

# NSM0402AT-HH Top-Inlet Analog Silicon Microphone Specification

**Rev 1.0** 



#### GENERAL DESCRIPTION

NSM0402AT-HH is a Silicon Microphone with analog output and top inlet for sound input. It is a cost-effective alternative to traditional electret condenser microphone (ECM). Provided on tap-and-reel, it is ideally suited for high volume applications. And it can be processed directly to customer's PCB using standard automatic pick-and-place equipment and surface mounted via standard solder reflow equipment.

NSM0402AT-HH is a new Silicon Microphone with Maximum RF protection. It uses a new anti-interference circuit to avoid RF interference. It is great convenience for customers to solve terminal RF interference.

NSM0402AT-HH can be used in (but not limited to) the following applications:

- 1. Portable communication device
- 2. Notebook and desktop
- 3. Headphone and headset accessories

### 2. ABSOLUTE MAXIMUM RATINGS

Supply voltage: VDD to GND....- $0.3V \sim 5V$  ESD Tolerance
The Lid Mode .....8kVThe I/O Pin Mode .....4kV

TEMPERATURE CHARACTERISTICS					
Parameter Conditions Min Typ Max Unit				Unit	
Operating Temperature		-40		+85	$^{\circ}$
Storage Temperature	Solder on PC board	-40		+105	$^{\circ}$
Storage Temperature	In Tape and Reel	-10		+50	$^{\circ}$



# 3. ACOUSTIC & ELECTRICAL SPECIFICATIONS

Unless otherwise specified, test conditions are:

Typical specifications are measured at VDD =3.3V

Input sound pressure  $P_{IN}$  = 94dB SPL@1kHZ

Test room temperature Ta =  $25\,^{\circ}$ C, Room Humidity =  $50\pm20\%$ 

SNR & noise floor measurement is based on 20 – 20 KHz pass band with A-Weighting

Filter applied

PERFORMANCE					
Parameter	Conditions	Min	Тур	Max	Unit
Directivity		Omni-Directional			
Sensitivity	@1 KHz (0  dB = 1 V/Pa)	-45	-42	-39	dB
Signal-to-Noise Ratio	@1 KHz (0  dB = 1 V/Pa)		61		dB
Total Harmonic Distortion (THD) @ 100dB SPL	@1KHz		0.2	0.5	%
Total Harmonic Distortion (THD) @ 115dB SPL	@1KHz		0.5	1	%
Max Input Sound Pressure	@1KHz, THD < 10%		130		dB SPL
Power Supply Rejection (PSR)	217Hz,100m Vpp square wave		-84	-79	dB
	INPUT CHARACTERISTICS				
Power supply Voltage		1.6		3.6	V
Sensitivity Loss Across Power Supply Voltage	Change in sensitivity from 1.6V to 3.6V power supply voltage	No change dB		dB	
Total Operation Current	1.6V-3.6V power supply voltage		75	85	uA
OUTPUT CHARACTERISTICS					
Output Impedance	@1 KHz (0  dB = 1  V/Pa)			200	Ω



## 4. FREQUENCY RESPONSE CURVE

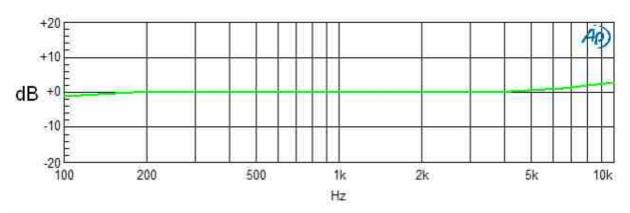
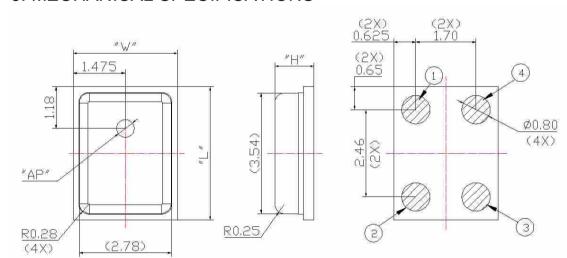


Figure 1. Typical free field frequency response (Normalized to 1 KHz)

## 5. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH(L)	3.76	±0.10	mm
WIDTH(W)	2.95	±0.10	mm
HEIGHT(H)	1.10	±0.10	mm
ACOUSTIC PORT(AP)	ф 0.50	±0.10	mm

PIN OUTPUT		
PIN#	FUNCTION	
1	POWER(Vdd)	
2	GROUND	
3	GROUND	
4	OUTPUT	

Note:

Dimensions are in millimetres unless otherwise specified. Tolerance  $\pm 0.15$ mm unless otherwise specified

Figure 2. Detailed mechanical drawings

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## 6. RECOMMENDED CUSTOMER LANDING PATTERN

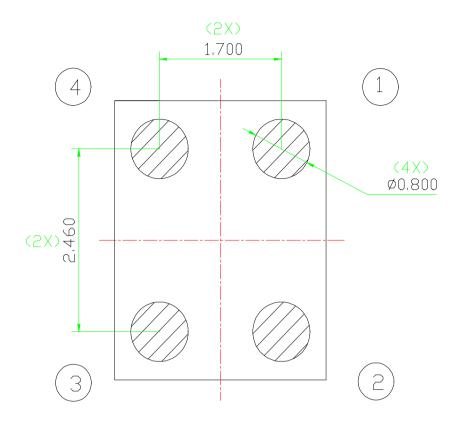


Figure 3. Recommended landing pattern on customers' PCB

# 7. RECOMMENDED INTERFACE CIRCUIT

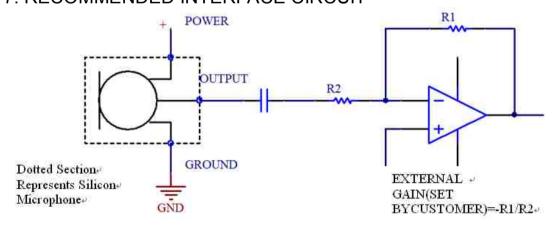
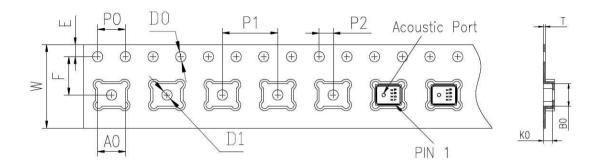


Figure 4. Recommended interface circuit for customers' applications

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# 8. PACKAGING SPECIFICATIONS



D0	$1.5 \pm 0.10$	W	$12.0 \pm 0.30$
D1	$1.5 \pm 0.10$	Е	$1.75 \pm 0.10$
A0	$4.06 \pm 0.10$	F	$5.50 \pm 0.10$
В0	$3.30 \pm 0.10$	P0	$4.00\pm0.10$
K0	$1.35 \pm 0.10$	P1	$8.00 \pm 0.10$
Т	$0.3 \pm 0.05$	P2	$2.00\pm0.10$

#### Notes:

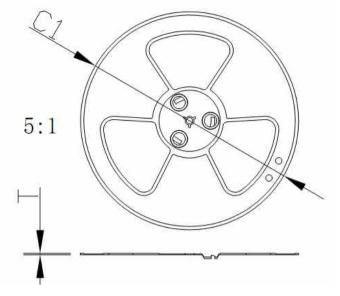
- (1) Tape & Reel Per EIA-481 standard;
- (2) Label applied to external package and direct to reel

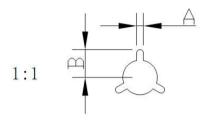
Order Part Number	Reel Diameter	Qty per Reel
NSM0402AT-HH	13"	5,000

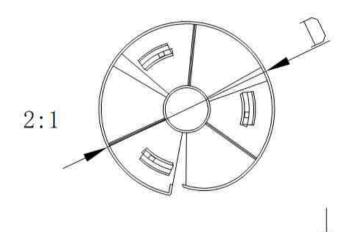
Figure 5. Tape Specification

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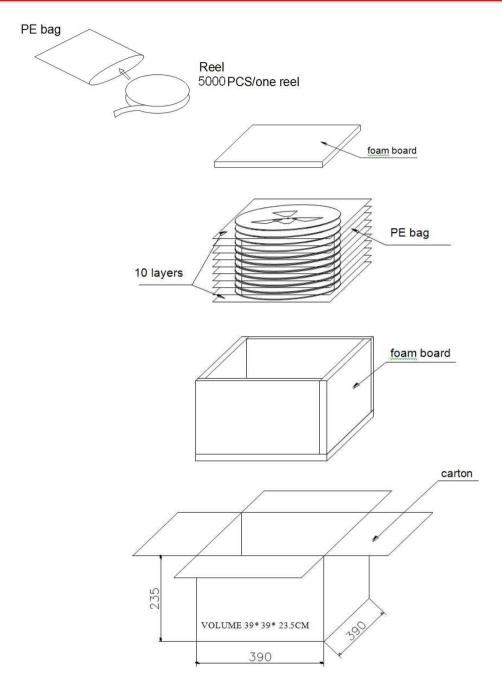
SPEC	13"
C1 ± 1.0	Ф330
A±0.2	2.6
B±0.2	10.8
T±0.2	2.0

Avaliable Reel Size(mm)			
Tape Width $D \pm 0.5$ H+1			
12	Ф100	12.5	

5,000PCS PRODUCTS/1 reel

Figure 6. Reel Specification



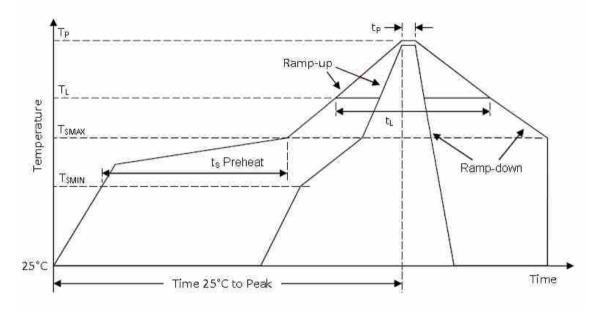


50,000 Pieces of Products per Carton

Figure 7 Packaging Specification



## 9. SOLDER REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate $(T_{SMAX} \text{ to } T_P)$	3°C/second max.
$ \begin{array}{c} \text{Preheat} \\ \text{Temperature Min } (T_{\text{SMIN}}) \\ \text{Temperature Max } (T_{\text{SMAX}}) \\ \text{Time } (T_{\text{SMIN}} \text{ to } T_{\text{SMAX}}) (t_{S}) \end{array} $	150°C 200°C 60-180 seconds
	217°C 60-150 seconds
Peak Temperature (T <sub>P</sub> )	260℃
Time within 5°C of actual Peak Temperature (t <sub>P</sub> )	20-40 seconds
Ramp-down rate(T <sub>P</sub> to T <sub>SMAX</sub> )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Figure 8 Recommended leadless solder reflow temperature profile

#### Notes:

- 1. Vacuuming over acoustical hole of the microphone is not allowed, because the Devices can be damaged by vacuum.
- 2. Washing the board after reflow process is not allowed, because board washing and Cleaning agents can damage the device. A device should not be exposed to ultrasonic processing or cleaning.
- 3. Recommended number of reflow is no more than 5 times.

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# 10. RELIABILITY SPECIFICATIONS

Test item	Detail	standard
Reflow Simulation	Refer to Sec.9 for solder reflow profile, total 5 times	/
Low Temperature Bias	Conditions:-40°C Duration:168 hours while under bias	IEC 60068-2-2 Test Aa
High Temperature Bias	Conditions: 105°C Duration:168 hours while under bias	IEC 60068-2-2 Test Ba
Thermal Shock	Conditions: 100 cycles of air-air thermal shock from -40 °C to 125 °C with 15-minute soaks	IEC 60068-2-4
Temperature/Humidity Bias	Conditions: 85 °C /85%RH environment while under bias for 168 hours	JESD 22-A101A-B
Mechanical Shock	Conditions:3 pulses of 10,000g in the X,Y and Z direction	IEC 60068-2-27 Test Ea
Vibration Test	Test axis: X,Y,Z Conditions: 2~400Hz 1 oct/min Test time: 15 mins per axis Use fixture during the testing	IEC 60068-2-6
Drop Test	Conditions: For each sample, drop by all corners, edges, surfaces respectively. Steel floor. Drop height: 1800mm.	IEC 60068-2-32
ESD	Conditions:  ±8KV direct contact to the lid when unit is grounded ,±4KV direct contact to the I/O pins.10 times	IEC 61000-4-2

Note: Immediately after reliability test, the samples shall be stored under climatic conditions such as that normally exist in ordinary rooms or laboratories. Unless otherwise noted, the recovery period shall be 2 hours at least before performance testing. After test condition is performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

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NSM0402AT-HH

### 11. REVISION HISTORY:

Version	Date	Description
1.0	20/12/2013	Initial release

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